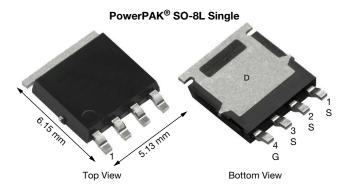
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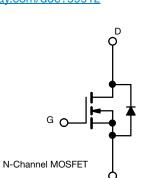
# Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY	
V <sub>DS</sub> (V)	40
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.00940
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.01173
I <sub>D</sub> (A)	20
Configuration	Single
Package	PowerPAK SO-8L

#### FEATURES

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified
- 100 %  $R_q$  and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





ABSOLUTE MAXIMUM RATINGS (T	<sub>C</sub> = 25 °C, unles	s otherwise noted	)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	40	V
Gate-source voltage		V <sub>GS</sub>	± 20	V
Continuous drain current <sup>a</sup>	T <sub>C</sub> = 25 °C	I-	20	
Continuous drain current -	T <sub>C</sub> = 125 °C	Ι <sub>D</sub>	20	
Continuous source current (diode conduction) <sup>a</sup>		IS	20	А
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	80	
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	18	
Single pulse avalanche energy		E <sub>AS</sub>	16	mJ
Maximum power dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	PD	27	W
Maximum power dissipation -	T <sub>C</sub> = 125 °C	C <sub>C</sub> = 125 °C 9		
Operating junction and storage temperature rang	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature)	d, e		260	U

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	70	°C/W
Junction-to-case (drain)		R <sub>thJC</sub>	5.5	0/10

#### Notes

- a. Package limited
- b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT		
Static				•		•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	1.3	1.8	2.3	v	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V	-	-	1	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C	-	-	50	- V nA μA Δ 3 0	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	250		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	10	-	-	А	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 6 A	-	0.00770	0.00940		
	P	V <sub>GS</sub> = 4.5 V	$I_D = 4 A$	-	0.00970	0.01173	0	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 6 A, T <sub>J</sub> = 125 °C	-	-	0.01370	Ω	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 6 A, T <sub>J</sub> = 175 °C	-	-	0.01600		
Forward transconductance b	g <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 6 A	-	32	-	S	
Dynamic <sup>b</sup>								
Input capacitance	C <sub>iss</sub>			-	1197	1700		
Output capacitance	Coss	$V_{GS} = 0 V$	$V_{DS}$ = 25 V, f = 1 MHz	-	331	500	pF	
Reverse transfer capacitance	C <sub>rss</sub>			-	31	50		
Total gate charge <sup>c</sup>	Qg		V <sub>DS</sub> = 20 V, I <sub>D</sub> = 1 A	-	22	33	nC	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	3.5	-		
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	3.9	-		
Gate resistance	R <sub>q</sub>	f = 1 MHz		1.74	3.49	5.30	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 20 \Omega$ $\text{I}_{D} \cong 1 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		-	10	20	ns	
Rise time <sup>c</sup>	t <sub>r</sub>			-	4	10		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	24	50		
Fall time <sup>c</sup>	t <sub>f</sub>			-	25	50		
Source-Drain Diode Ratings and Charac	teristics <sup>b</sup>	•			·			
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	80	А	
Forward voltage	V <sub>SD</sub>	$I_{\rm F} = 6  {\rm A},  {\rm V}_{\rm GS} = 0$		-	0.77	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>			-	28	60	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 1 A, di/dt = 100 A/μs		-	17	35	nC	
Reverse recovery fall time	ta			-	14	-		
Reverse recovery rise time	t <sub>b</sub>			-	14	-	ns	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-1.1	-	А	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

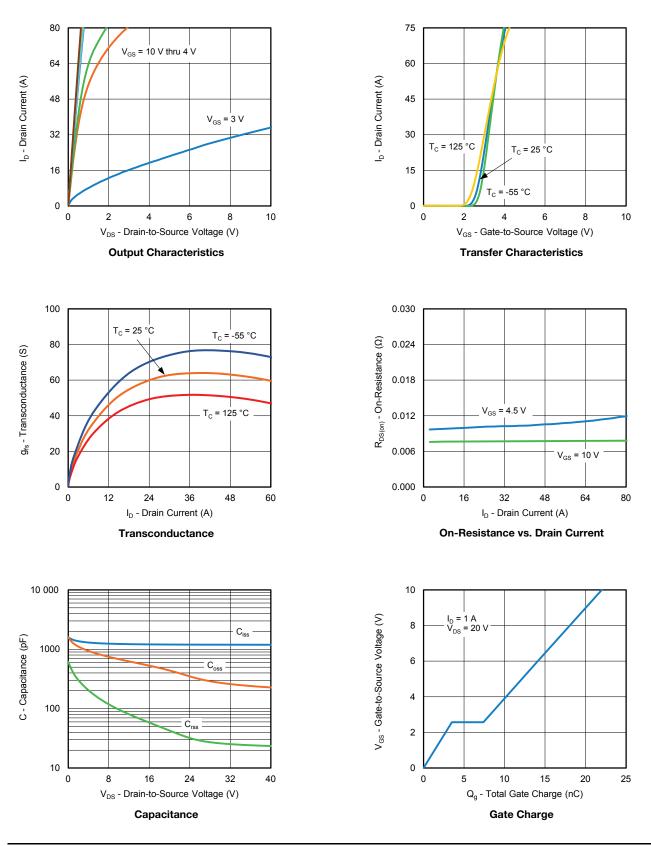
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



S19-0024-Rev. B, 14-Jan-2019

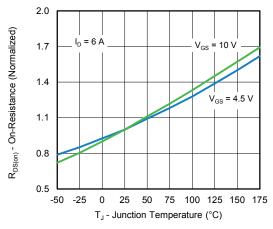
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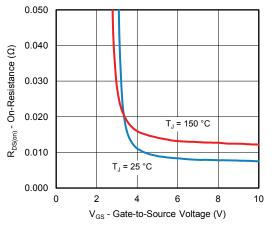


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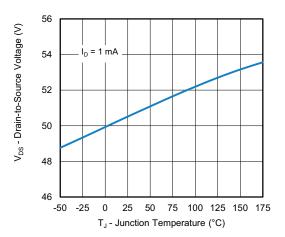
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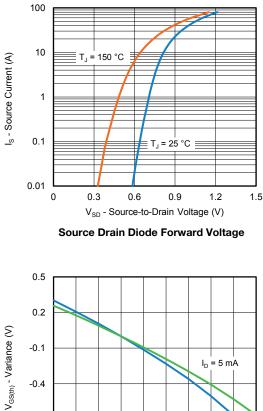
**On-Resistance vs. Junction Temperature** 

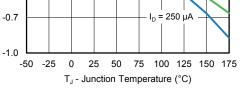


**On-Resistance vs. Gate-to Source Voltage** 

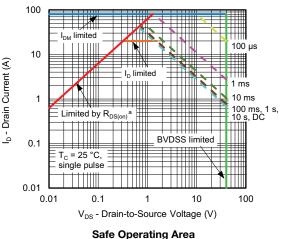


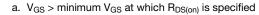
Drain Source Breakdown vs. Junction Temperature





**Threshold Voltage** 





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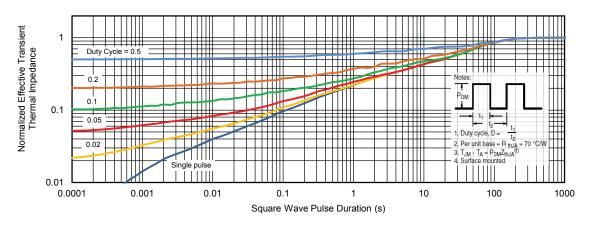
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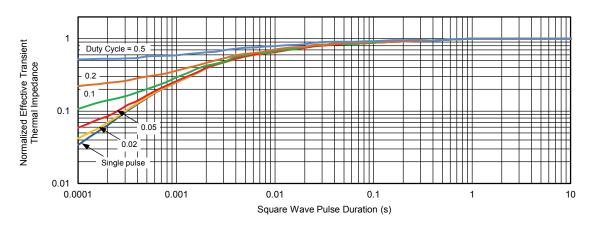


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### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

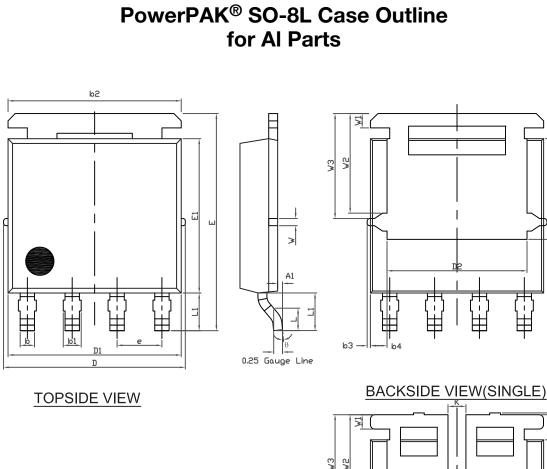
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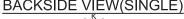
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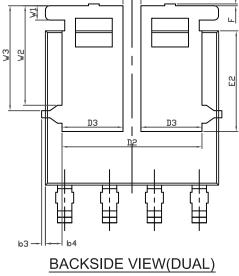
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Revision: 07-Sep-15





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# **Package Information**



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DIM		MILLIMETERS			INCHES			
DIM.	MIN.	MIN. NOM. MAX			NOM.	MAX.		
А	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094	•		0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC	•	0.050 BSC				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	2.75	2.85	2.95	0.108	0.112	0.116		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
К		0.51			0.020			
W		0.23			0.009			
W1		0.41			0.016			
W2	2.82			0.111				
W3		2.96			0.117			
q	0°	-	10°	0°	-	10°		

Note

• Millimeters will gover



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### RECOMMENDED MINIMUM PAD FOR PowerPAK<sup>®</sup> SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



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